

## Tilt Sensor Switch

|          |            |             |              |               |   |
|----------|------------|-------------|--------------|---------------|---|
| Item No. | RBS210403T | Description | Ball-Contact | Version       | 2 |
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### ● FUNCTION

15° Tilt Detecting in one axis.

### ● APPLICATIONS

1. Water filtration module
2. Wake up systems for power saving, such like remote controllers.
3. Anti-theft / Anti-tamper devices
4. Alarm system
5. Earthquake detecting
6. Toys, Entertainment device



### ● FEATURES

1. Suitable for horizontal PCB.
2. Switch state: SMD Normally Closed.
3. Gold-plated ball and terminals, low possibility of oxidization.
4. Housing made of high insulation plastic material, free from electric conduction and rust problem.
5. All plastic materials subject to industrial purpose, resist high temperature.
6. Simple ON and OFF signals, easy for design.
7. RoHS compliance, an ideal substitute for mercury switch.
8. A more economical tilt detection option than IC design solution.
9. All made in Taiwan and examined before shipment.

### ● PATENT

1. Taiwan Patent No. 226086

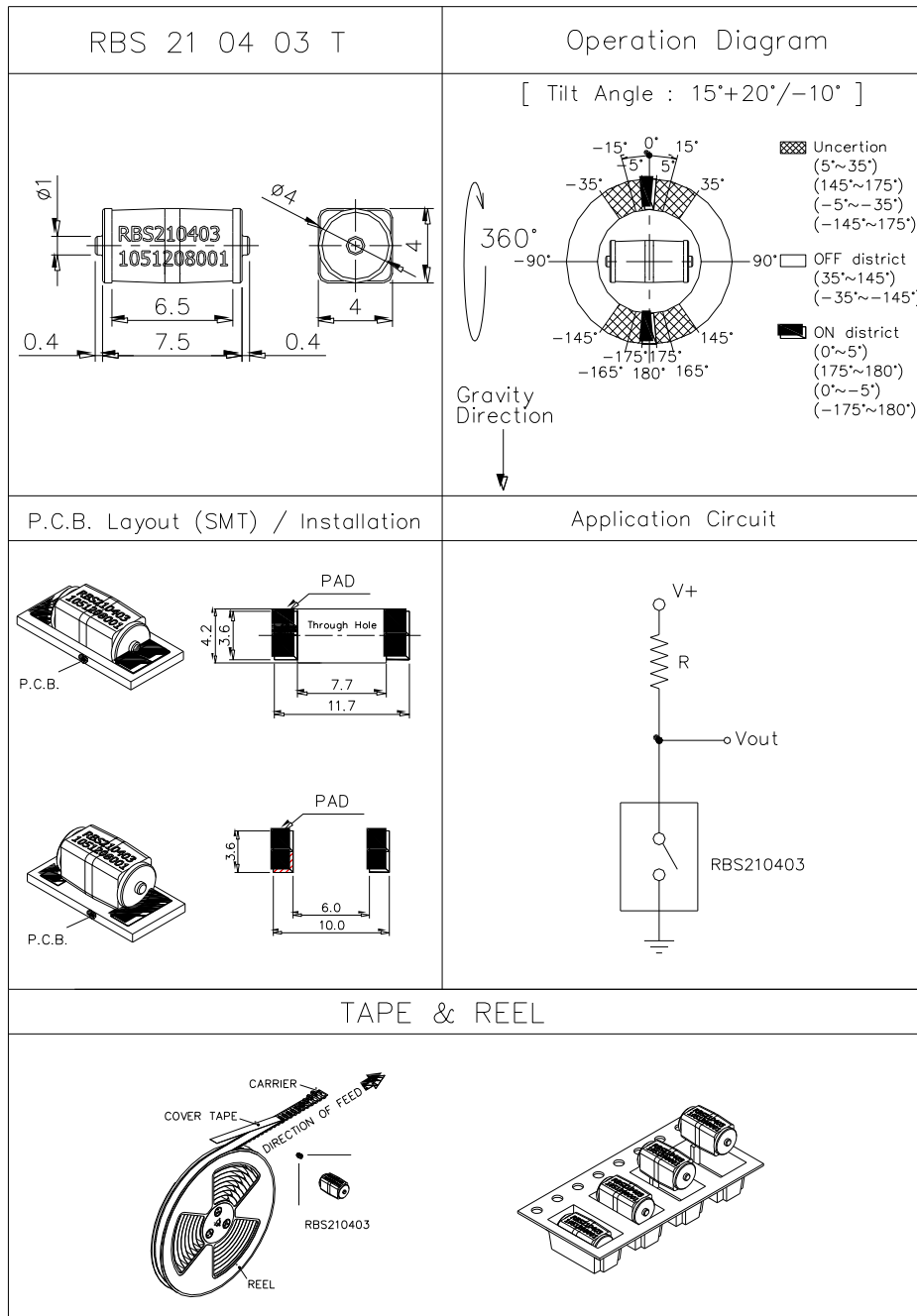


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● DIMENSIONS / OPERATION / P.C.B. LAYOUT (Unit: mm, Tolerance: ±0.25mm)

Fig. 1



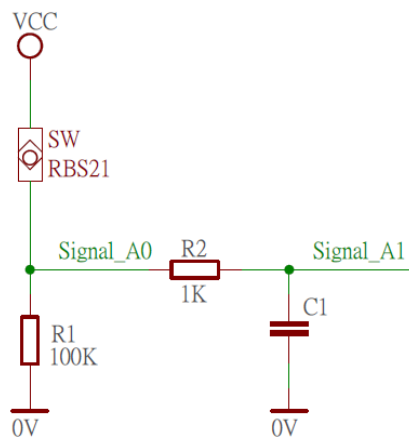
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### Application Circuit

#### (1) Type1 Circuit

Note : We suggest add RC filter circuit (see R2, C1) after Original detect signal (signal\_A0). Application circuit as below.



The higher the RC value is, the better the effect of filter is. RC filter circuit could filter out more vibrate noise. But the delay time of signal (Signal\_A1) will be longer than before (Signal\_A0).

The delay time of signal happens during C1 discharge. It will take  $t=5RC$  for C1 discharge through R2 and R1 to ground (0V).

As above circuit, when  $C1=1\mu F$  that delay about 0.5s  
 $t = 5 * (R1+R2)*C1 = 5 * (100K+1K) * 1\mu F = 0.505 \text{ sec}$

We suggest  $t > 0.5s$ ,

**User could adjust C1 to appropriate parameter to fit your product**



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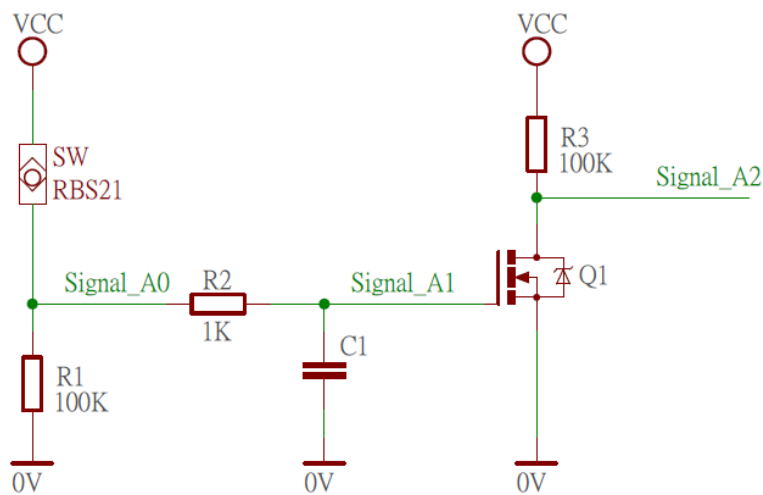
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### (2) Type2 Circuit

Note : If MosFET is added to Type1 circuit; the effect of filter will be better

Especially, for the circuit with load effect after Signal\_A1, you better add MosFET circuit. Then you get Signal\_A2 phase is inverse to Signal\_A0

Operate voltage  $V_{cc}=5V$ , we suggest MosFET could use model 2N7000 or the same specification model.



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● Current/Voltage Suggested

| Input Current (mA) | Operating Voltage (V) | Condition |
|--------------------|-----------------------|-----------|
| 1.0                | 5                     | --        |

● ELECTRICAL CHARACTERISTICS

|   |                       |                       |
|---|-----------------------|-----------------------|
| 1 | Contact Rating        | 10 mA, 5 VDC          |
| 2 | Contact Resistance    | 50 Ω max.             |
| 3 | Operation Diagram     | Refer to Fig. 1       |
| 4 | Insulation Resistance | 1000 MΩ min., 100 VDC |
| 5 | Dielectric Strength   | 50 VDC min., 1 minute |
| 6 | Capacitance           | 5 pF max.             |
| 7 | Conductive Rate       | 90% min.              |



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● **RELIABILITY TEST ITEMS**

Reliability Test for RBS210403T

|   | Test Item             | Contents                           |
|---|-----------------------|------------------------------------|
| 1 | IR Reflow             | Peak temp.=255~260°C               |
| 2 | Operating Temperature | -25°C ~ 85°C                       |
| 3 | Storage Temperature   | -40°C ~ 85°C                       |
| 4 | Humidity              | 40 °C / 95 %RH                     |
| 5 | Mechanical Life       | 2 Hz horizontal<br>1,000,000 times |
| 6 | Electrical Life       | 100,000 times                      |

● **SOLDERING CONDITION**

Following soldering conditions are for reference only, please use soldering information that solder paste manufacturer recommends.

| Condition                   | Soldering Temperature   | Soldering Time   | Wattage of Manual Soldering                    | Type |
|-----------------------------|---|------------------|--|------|
| Suitable Production Process |   |                  |  |      |
| IR Reflow                   | Please refer to following < Table of classification Reflow profile > and Fig. 2 |                  | -  | SMD  |
| Manual Soldering            | 300±5°C   | < 3 seconds max. | 30W or Temperature-controlled manual soldering | SMD  |



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< Table of classification Reflow profile >

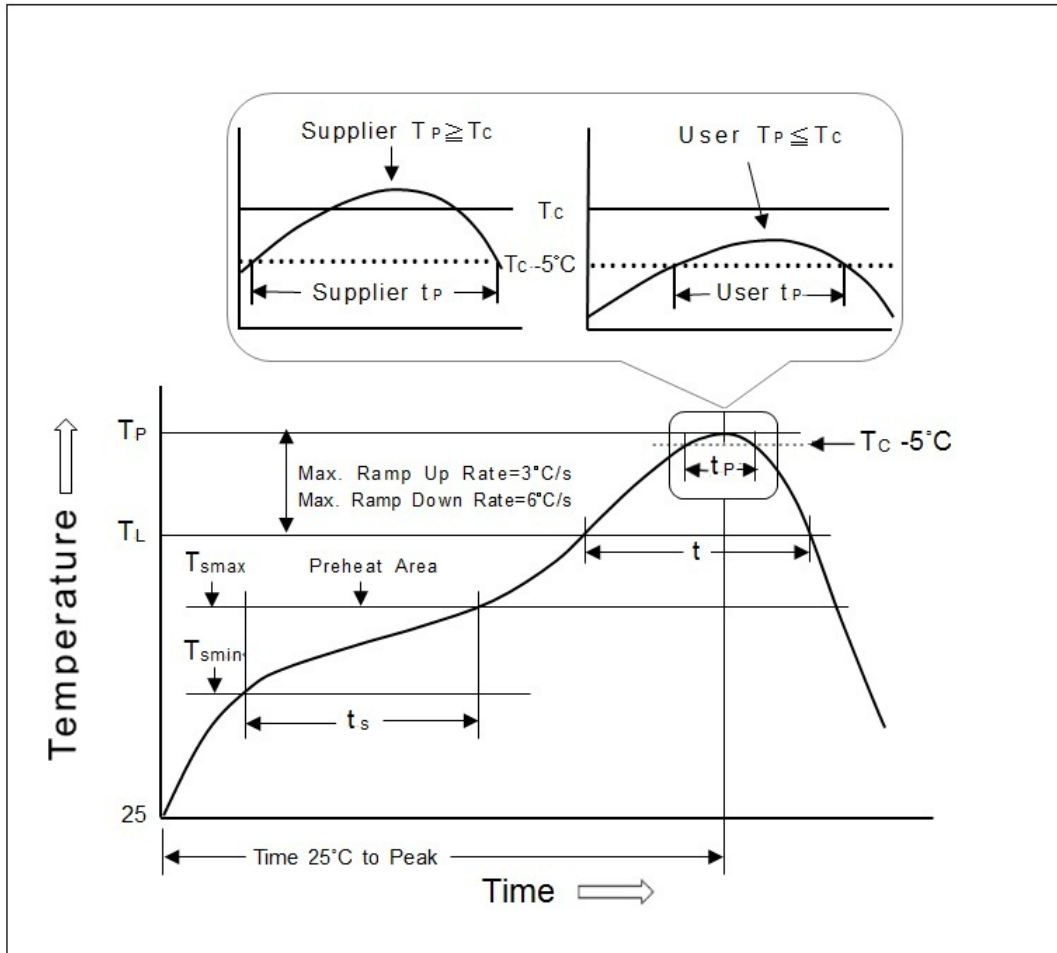
| Item   | Pb process      | Pb free process |
|--|-----------------|-----------------|
| Pre-heat and Soak  |                 |                 |
| Temperature min.(T <sub>min</sub> )  | 100°C           | 150°C           |
| Temperature max.(T <sub>max</sub> )  | 150°C           | 200°C           |
| Time (T <sub>min</sub> to T <sub>max</sub> )(ts)   | 60-120 seconds  | 60-120 seconds  |
| Average Rate of temperature rising up (T <sub>max</sub> to T <sub>p</sub> )  | 3°C/second max. | 3°C/second max. |
| Liquidous Temperature (TL)   | 183°C           | 217°C           |
| Time at Liquidous (tL)   | 60-150 seconds  | 60-150 seconds  |
| Peak package body Temperature (T <sub>p</sub> )*   | 230°C ~235°C *  | 255°C ~260°C *  |
| Classification temperature(T <sub>c</sub> )  | 235°C           | 260°C           |
| Time(tp)** within 5 °C of the specified classification temperature (T <sub>c</sub> )   | 20** seconds    | 30** seconds    |
| Average ram-down Rate (T <sub>p</sub> to T <sub>max</sub> )  | 6°C/second max. | 6°C/second max. |
| Time 25 °C to peak temperature   | 6 minutes max.  | 8 minutes max.  |
| * Tolerance for peak profile temperature (T <sub>p</sub> ) is defined as a supplier minimum and a user maximum.<br>** Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum. |                 |                 |



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Fig. 2





**Tilt Sensor Switch**

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● PACKAGE

|    | Part Number | Package   | Quantity  | Total      | Dimension (mm) |
|----|-------------|-----------|-----------|------------|----------------|
| 1. | RBS210403   | PE bag    | 1,000 pcs | 1,000 pcs  | 205L*145W      |
|    |             | Inner box | 10PE bag  | 10,000 pcs | 348L*191W*85H  |
|    |             | Carton    | 3 boxes   | 30,000 pcs | 364L*278W*213H |

※ Package shown as below for reference.



|    | Part Number | Package     | Quantity  | Total      | Dimension (mm) |
|----|-------------|-------------|-----------|------------|----------------|
| 2. | RBS210043T  | Tape & reel | 2,000 pcs | 2,000 pcs  | φ330*17H       |
|    |             | Inner box   | 2 reels   | 4,000 pcs  | 355L*340W*68H  |
|    |             | Carton      | 10 boxes  | 40,000 pcs | 703L*364W*380H |

※ Package shown as below for reference.



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### ● NOTE

1. Suggestion for usage: For vibration usage or application, we suggest to add hysteresis for IC; if vibration is strong, optical type of sensor switch is recommended.
2. The continuous improvement on product as one of the company policy, specifications may be changed or updated without notice. The latest information can be obtained through our sales offices. Normally, all products are produced based on this datasheet.

### ● PRECAUTIONS FOR USE

1. If the product is applied for the device such as life support system, space and aviation devices, disaster and safety system, which safety and reliability are critical, it's necessary to make verification or contact us for the details before using.
2. Do not clean the switch with solvent-like substance after the soldering process.
3. Using water soluble flux may damage the switch.
4. Please follow the soldering instruction accordingly, otherwise might lead to defective.
5. Do not use switch in the highly humid environment which may cause the current leakage between the terminals.
6. Please do not exceed the rated load as there will be a risk of disabling the product function.
7. In the circuit, the switch should not be near or directly connected with the magnetic component solder joints (for example: relays, transformers, etc.).

